

S&H Form: (02/05)

## **REPLY/AMENDMENT FEE TRANSMITTAL**

Attorney Docket No. 1186.1033 Application Number 10/808,502 Filing Date March 25, 2004 First Named Inventor Takehito TSUKAMOTO et al. Group Art Unit 2841

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Attorney Docket No. 1186.1033

Group Art Unit: 2841

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Takehito TSUKAMOTO et al.

Application No.: 10/808,502

Confirmation No.: 5712

Filed: March 25, 2004

Examiner: Hoa Cao NGUYEN

MULTI-LAYER WIRING BOARD, IC PACKAGE, AND METHOD OF MANUFACTURING

MULTI-LAYER WIRING BOARD

## **AMENDMENT**

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

This is in response to the Office Action mailed May 26, 2006, and having a period for response set to expire on August 26, 2006. A Petition for a one-month extension of time, together with the requisite fee for same, is submitted herewith, thereby extending the period for response to September 26, 2006.

The following amendments and remarks are respectfully submitted. Reconsideration of the claims is respectfully requested.

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